



## DMNH6042SSDQ

### 60V DUAL N-CHANNEL 175°C MOSFET

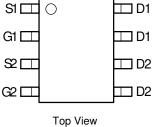
## **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>C</sub> = +25°C
	50mΩ @ V <sub>GS</sub> = 10V	16.7A
60V	$65m\Omega @ V_{GS} = 4.5V$	14.6A

## **Description and Applications**

This MOSFET is designed to meet the stringent requirements of Automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- Engine Management Systems
- Body Control Electronics
- DC-DC Converters
  - Top View



SO-8

Pin Configuration



Part Number	Case	Packaging
DMNH6042SSDQ-13	SO-8	2,500/Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

 See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

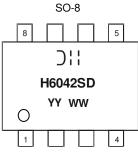
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/quality/product\_compliance\_definitions.html.

5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

# **Marking Information**

Notes:



)::= Manufacturer's Marking
H6042SD = Product Type Marking Code
YYWW = Date Code Marking
YY = Year (ex: 16 = 2016)
WW = Week (01 - 53)

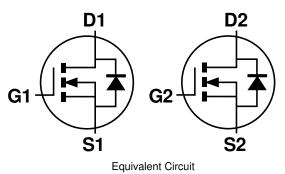
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## **Features and Benefits**

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- Low R<sub>DS(ON)</sub> Minimizes Power Losses
- Low Q<sub>G</sub> Minimizes Switching Losses
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

# **Mechanical Data**

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (23)
- Weight: 0.076 grams (Approximate)





# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Drain-Source Voltage	V <sub>DSS</sub>	60	V		
Gate-Source Voltage	V <sub>GSS</sub>	±20	V		
Continuous Drain Current (Note 7) $V_{GS} = 10V$	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	5.3 4.4	А
	Steady State	T <sub>C</sub> = +25°C T <sub>C</sub> = +100°C	ID	16.7 14	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%	I <sub>DM</sub>	35	А		
Maximum Continuous Body Diode Forward Current	I <sub>S</sub>	2.3	А		
Avalanche Current (Note 8) L = 10mH	IAS	3.5	А		
Avalanche Energy (Note 8) L = 10mH			E <sub>AS</sub>	65	mJ

### **Thermal Characteristics**

Characteristic		Symbol	Value	Units
Total Power Dissipation (Note 6)		PD	1.5	W
Thermal Resistance, Junction to Ambient (Note 6) Steady State t<10s		R <sub>0JA</sub>	100 61	°C/W
Total Power Dissipation (Note 7)	1(103	PD	2.1	W
Thermal Resistance, Junction to Ambient (Note 7) Steady State t<10s		R <sub>θJA</sub>	72 44	°C/W
Thermal Resistance, Junction to Case (Note 7)	R <sub>ejc</sub>	7.25		
Operating and Storage Temperature Range		T <sub>J,</sub> T <sub>STG</sub>	-55 to +175	°C

# Electrical Characteristics (@T<sub>A=</sub> +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	60	—	—	V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current $T_J = +25^{\circ}C$	I <sub>DSS</sub>	_	—	1	μΑ	$V_{DS} = 60V, V_{GS} = 0V$	
Gate-Source Leakage	Igss	—	—	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	1.0	—	3.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance	Proven		34	50	mΩ	$V_{GS} = 10V, I_D = 5.1A$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	45	65	11152	$V_{GS} = 4.5V, I_D = 4.4A$	
Diode Forward Voltage	V <sub>SD</sub>	_	0.8	1.2	V	$V_{GS} = 0V, I_{S} = 2.6A$	
DYNAMIC CHARACTERISTICS (Note 10)	-						
Input Capacitance	CISS		584	—	pF	V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V, f = 1.0MHz	
Output Capacitance	C <sub>OSS</sub>		83	—	pF		
Reverse Transfer Capacitance	C <sub>RSS</sub>		24	—	pF	1 - 1.00012	
Gate Resistance	R <sub>G</sub>	_	3.8	-	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Q <sub>G</sub>	_	4.2	—	nC		
Total Gate Charge (V <sub>GS</sub> = 10V)	Q <sub>G</sub>	_	8.8	—	nC	Vps = 44V. lp = 5.2A	
Gate-Source Charge	Q <sub>GS</sub>	_	1.8	—	nC	$V_{DS} = 44V, I_D = 5.2A$	
Gate-Drain Charge	Q <sub>GD</sub>		1.8	—	nC		
Turn-On Delay Time	t <sub>D(ON)</sub>	_	3.4	—	ns		
Turn-On Rise Time	t <sub>R</sub>	_	1.9	—	ns	$V_{GS} = 10V, V_{DS} = 30V,$	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	10.1	_	ns	$R_G=6\Omega,\ I_D=1A$	
Turn-Off Fall Time	tF		4.5	_	ns		
Body Diode Reverse Recovery Time	t <sub>RR</sub>	_	12.9	—	ns		
Body Diode Reverse Recovery Charge	Q <sub>RR</sub>	—	5.4	—	nC	- I <sub>F</sub> = 2.6A, di/dt = 100A/μs	

Notes: 6. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.

7. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate.

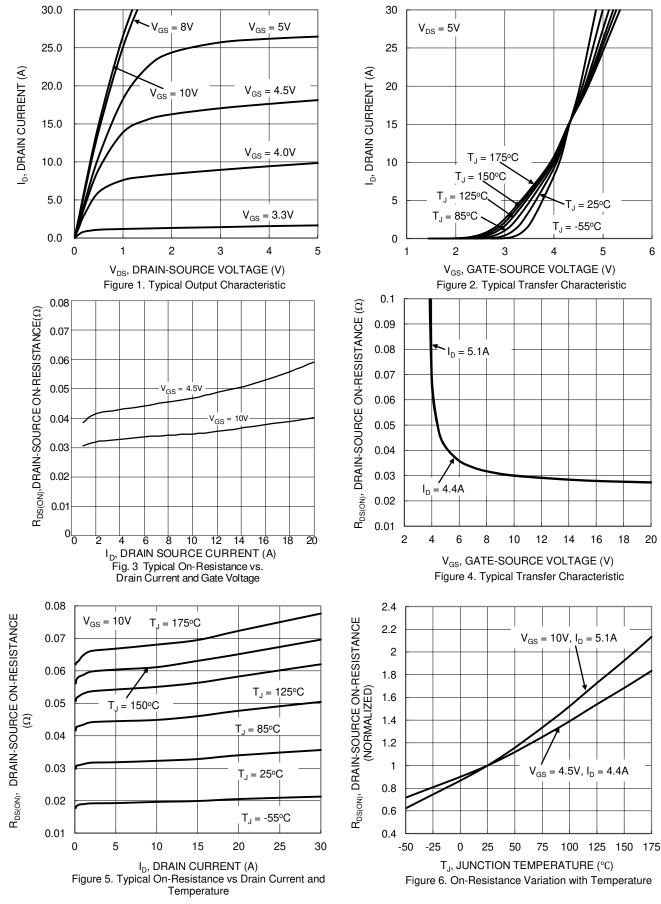
8.  $I_{AS}$  and  $E_{AS}$  rating are based on low frequency and duty cycles to keep  $T_J = +25^{\circ}C$ .

9. Short duration pulse test used to minimize self-heating effect.

10. Guaranteed by design. Not subject to product testing.

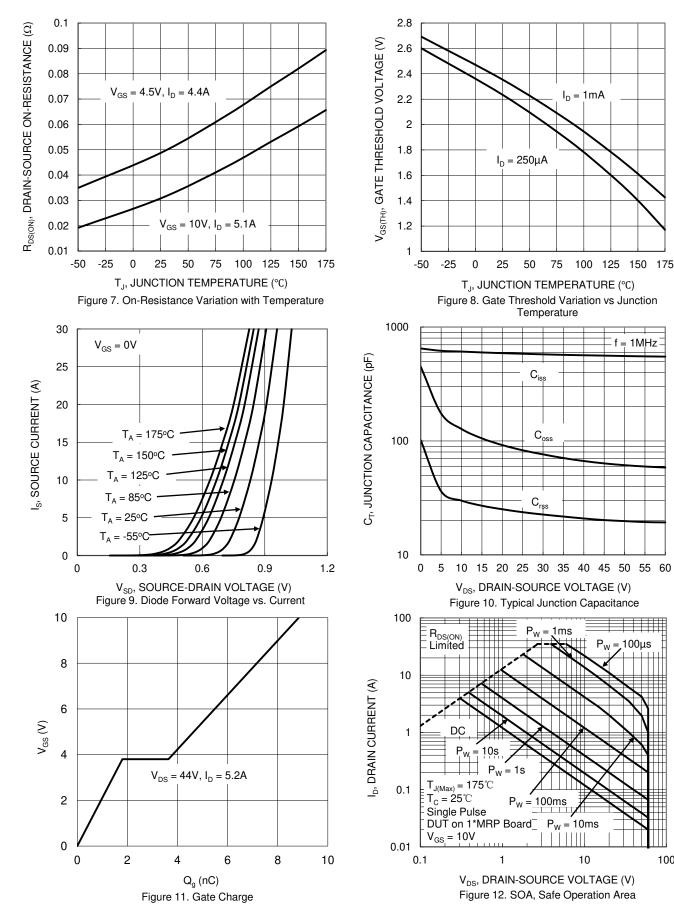


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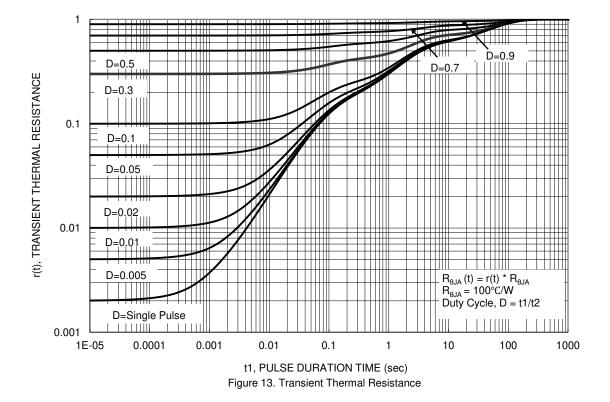


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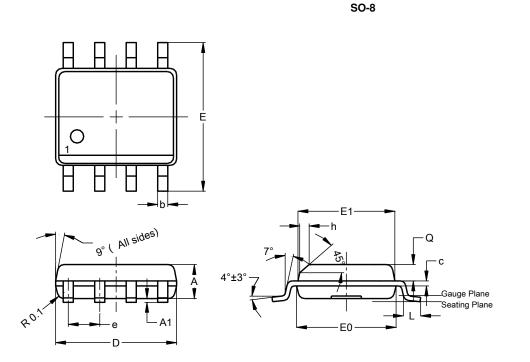






# **Package Outline Dimensions**

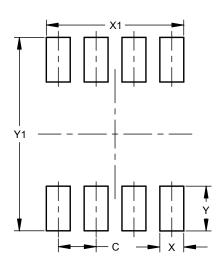
Please see http://www.diodes.com/package-outlines.html for the latest version.



SO-8						
Dim	Min	Max	Тур			
Α	1.40	1.50	1.45			
A1	0.10	0.20	0.15			
b	0.30	0.50	0.40			
c	0.15	0.25	0.20			
D	4.85	4.95	4.90			
ш	5.90	6.10	6.00			
E1	3.80	3.90	3.85			
E0	3.85	3.95	3.90			
e	I	I	1.27			
h	_	_	0.35			
L	0.62	0.82	0.72			
Q	0.60	0.70	0.65			
All Dimensions in mm						

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



SO-8

Dimensions	Value (in mm)
С	1.27
Х	0.802
X1	4.612
Y	1.505
Y1	6.50



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